UNITED STATES	S PATENT AND TRADEMARK OFFICE
BEFORE THE P	ATENT TRIAL AND APPEAL BOARD
_	
TAIWAN SEMICONDU	CTOR MANUFACTURING COMPANY, LTD.,
TSMC NORTH AMERICA	CORPORATION, ADVANCED MICRO DEVICES,
INC., RENESAS ELECTRO	NICS CORPORATION, RENESAS ELECTRONICS
AMERICA, INC., GLOBA	LFOUNDRIES U.S., INC., GLOBALFOUNDRIES

THE GILLETTE CO.
Petitioners

DRESDEN MODULE ONE LLC & CO. KG, GLOBALFOUNDRIES DRESDEN MODULE TWO LLC & CO. KG, TOSHIBA AMERICA ELECTRONIC COMPONENTS, INC., TOSHIBA AMERICA INFORMATION SYSTEMS, INC., TOSHIBA CORPORATION, and

V.

ZOND, LLC Patent Owner

Inter Partes Review Case No. IPR2014-00799

Patent 7,808,184 B2

AFFIDAVIT OF MARIA GRANOVSKY IN SUPPORT OF PATENT OWNER'S MOTION FOR *PRO HAC VICE* ADMISSION

I, Maria Granovsky, being duly sworn and upon oath, hereby attest to the following:



- i. I am a member in good standing of the New York and Delaware Bars, as well as the U.S. District Court for the District of Delaware.
- ii. I have not been suspended or disbarred from practice before any court or administrative body.
- iii. I have never had an application for admission to practice before any court or administrative body denied.
- iv. No sanction or contempt citation has been imposed against me by any court or administrative body.
- v. I have read and will comply with the Office Patent Trial Practice Guide and the Board's Rules of Practice for Trials set forth in part 42 of the Code of Federal Regulations.
- vi. I will be subject to the USPTO Rules of Professional Conduct set forth in 37 C.F.R. §§ 11.101 *et seq.* and disciplinary jurisdiction under 37 C.F.R. § 11.19(a).
- vii. Other than presently applying to appear *Pro Hac Vice* before the Office in connection with the *Inter Partes* Review proceedings of the patents listed below in section ix, I have not applied to appear *Pro Hac Vice* before the Office in any other proceeding in the last three years.
- viii. I am an experienced litigation attorney, with experience in many litigations involving patent infringement in District Courts across the



Patent No. 7,808,184 IPR2014-00799

country, including experience with fact and expert document and deposition discovery, claim construction, *Markman* hearings, motion

practice, trials and hearings.

related on-going litigations. I am familiar with the subject matter at issue in this proceeding as a result of my representation of Zond, LLC, in a matter currently before the District of Massachusetts (*Zond v. TSMC, et al.*, No. 1:14-cv-12438-WGY), in which the patents 6896775, 6896773, 6806651, 6903511, 7095179, and 7446479 have been asserted against several TSMC and Fujitsu entities. I am familiar with the prior art that Petitioner presents in this proceeding, as well as issues of claim construction as a result of my participation in the above litigation and related work that I have done on behalf of Zond.

Date: November 11, 2014

/Maria Granovsky/
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